

High Voltage NPN Power Transistors (3A, 1500V)

FEATURES

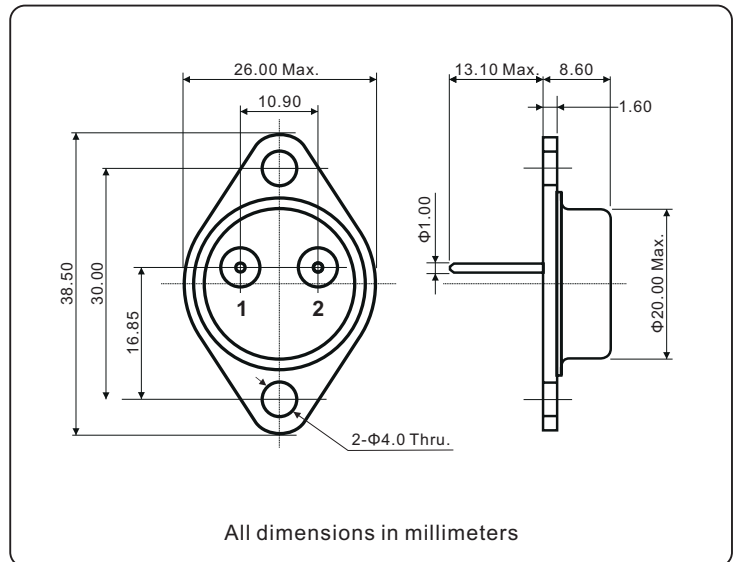
- High V_{CES} breakdown voltage.
- High collector peak current
- High reliability

DESCRIPTION

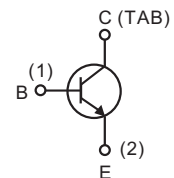
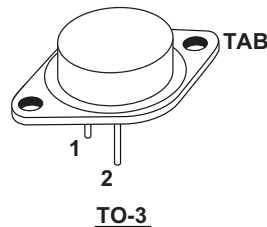
The **2SD649** is a silicon epitaxial-base mesa NPN transistor mounted in JEDEC TO-3 metal case.

APPLICATIONS

- Designed for line-operated horizontal deflection output



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise specified)

| SYMBOL | PARAMETER | VALUE | UNIT |
|-----------|--|------------|------------------|
| V_{CBO} | Collector to base voltage | 1500 | V |
| V_{CES} | Collector to emitter voltage ($V_{BE} = 0$) | 1500 | |
| V_{EBO} | Emitter to base voltage ($I_C = 0$) | 5 | |
| I_C | Collector current | 3 | A |
| I_{CP} | Collector peak current | 5 | |
| P_C | Total power dissipation ($T_C \leq 90^\circ\text{C}$) | 35 | W |
| T_j | Junction temperature | 130 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | -65 to 130 | |
| T_L | Maximum lead temperature for soldering purposes : 1/8" from case for 5 seconds | 275 | |

| ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified) | | | | | |
|---|---|--|-----|-----|---------------|
| SYMBOL | PARAMETER | CONDITIONS | MIN | MAX | UNIT |
| OFF CHARACTERISTICS | | | | | |
| I_{CBO} | Collector cutoff current | $V_{CB} = 750\text{V}, I_E = 0$ | | 100 | μA |
| | | $V_{CB} = 1500\text{V}, I_E = 0$ | | 1.0 | mA |
| I_{EBO} | Emitter cutoff current | $V_{EB} = 5\text{V}, I_C = 0$ | | 1.0 | |
| $V_{(BR)EBO}$ | Emitter to base breakdown voltage | $I_C = 0, I_E = 10\text{mA}$ | 5 | | V |
| $V_{CE(sat)}$ | Collector to emitter saturation voltage | $I_C = 3\text{A}, I_B = 1\text{A}$ | | 7.0 | |
| $V_{BE(sat)}$ | Base to emitter saturation voltage | $I_C = 3\text{A}, I_B = 1\text{A}$ | | 1.5 | |
| h_{FE} | DC current gain | $I_C = 3\text{A}, V_{CE} = 10\text{V}$ | 4 | 12 | |

| INDUCTIVE SWITCHING TIMES | | | | | | | |
|---------------------------|--------------|--|--------------------------|------|------|------|---------------|
| SYMBOL | PARAMETER | CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
| t_s | Storage time | $I_C = 3\text{A}, L_B = 20\mu\text{H}, I_{Bend} = 1\text{A}$ | $T_C = 25^\circ\text{C}$ | | 13 | | μs |
| t_f | Fall time | $I_C = 3\text{A}, L_B = 20\mu\text{H}, I_{Bend} = 1\text{A}$ | $T_C = 25^\circ\text{C}$ | | | 1.0 | |

Fig.1 Power dissipation vs. ambient temperature

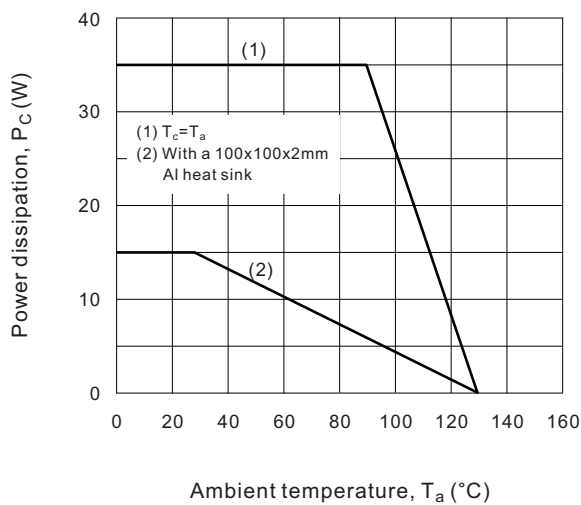


Fig.2 Base-Emitter saturation voltage

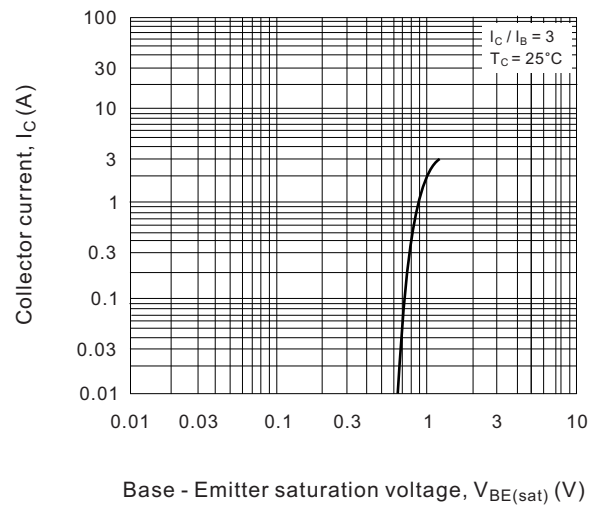
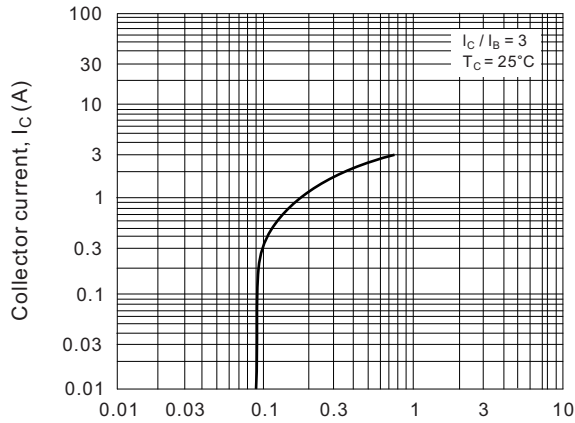
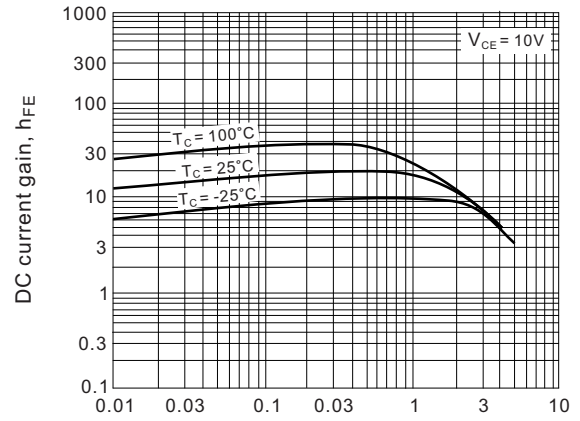


Fig.3 Collector-Emitter saturation voltage



Collector - Emitter saturation voltage, $V_{CE(sat)}$ (V)

Fig.4 DC current gain



Collector current, I_C (A)

Fig.5 Safe operation area

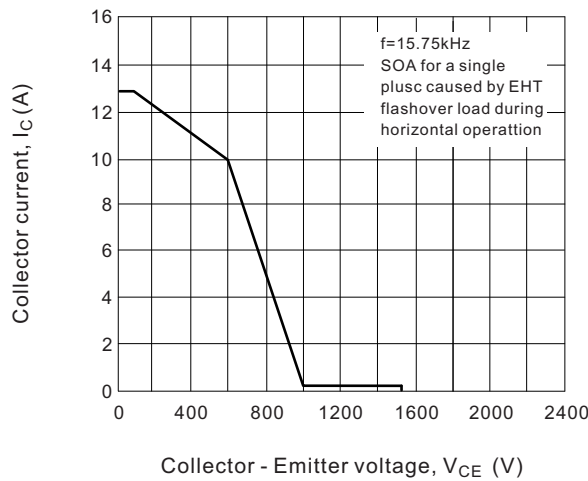


Fig.6 Thermal resistance (from junction to tab)

